April 2013



FGH20N60SFD 600 V, 20 A Field Stop IGBT

Features

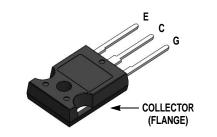
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 2.2 V @ I_C = 20A
- High Input Impedance
- Fast Switching
- RoHS Compliant

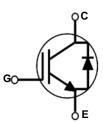
Applications

• Solar Inverter, UPS, Welder, PFC

General Description

Using novel field stop IGBT technology, Fairchild[®]'s field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit	
V _{CES}	Collector to Emitter Voltage		600	V	
V _{GES}	Gate to Emitter Voltage		± 20	V	
I _C	Collector Current	@ T _C = 25 ^o C	40	A	
·	Collector Current	@ T _C = 100°C	20	A	
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25 ^o C	60	A	
P _D	Maximum Power Dissipation	@ T _C = 25°C	165	W	
	Maximum Power Dissipation	@ T _C = 100 ^o C	66	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T _{stg}	Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	-	0.76	°C/W
$R_{\theta JC}$ (Diode)	$R_{\theta JC}$ (Diode) Thermal Resistance, Junction to Case		2.51	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	-	40	°C/W

Device N	ice Marking Device Pa		Package	Packaging ackage Type		Qty per Tube		Max Qty per Box	
-		FGH20N60SFDTU	TO-247 Tube		30ea		-		
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	al Cha	racteristics of the	-		N4 :	True		11	
Symbol		Parameter	lest	Conditions	Min.	Тур.	Max.	Unit	
Off Charac	teristics								
BV _{CES}	Collector	to Emitter Breakdown Voltag	e V _{GE} = 0V, I _C	ς = 250μΑ	600	-	-	V	
ΔBV _{CES} ΔT _J	Temperat Voltage	ure Coefficient of Breakdow	<u>_</u>	$V_{GE} = 0V, I_C = 250\mu A$		0.6	-	V/ºC	
ICES	Collector	Cut-Off Current	$V_{CE} = V_{CES}$	$V_{CE} = V_{CES}, V_{GE} = 0V$		-	250	μA	
I _{GES}	G-E Leak	age Current	$V_{GE} = V_{GES}$		-	-	±400	nA	
On Change	torioti		1		1			1	
On Charac	1	shold Voltage	I _C = 250μA,	$V_{CE} = V_{CE}$	4.0	5.0	6.5	V	
GE(th)			$I_{\rm C} = 200$ Å, $V_{\rm GE} = 15$ V		-	2.2	2.8	V	
V _{CE(sat)}	Collector	collector to Emitter Saturation Voltage		$I_{C} = 20A, V_{GE} = 15V,$ $T_{C} = 125^{\circ}C$		2.4	-	V	
	ļ				-			ļ	
Dynamic C C _{ies}	Input Cap				-	940		pF	
C _{ies} C _{oes}		apacitance	V _{CE} = 30V, V	V _{CE} = 30V, V _{GE} = 0V, f = 1MHz		110		pr	
C _{res}		Transfer Capacitance	f = 1MHz			40		pF	
ores	11010100					10		P	
Switching	Character	istics							
t _{d(on)}	Turn-On I	Delay Time				13	-	ns	
t _r	Rise Time	9			-	16	-	ns	
t _{d(off)}	Turn-Off I	Delay Time	$V_{CC} = 400V$, I _C = 20A,	-	90	-	ns	
t _f	Fall Time		$R_{G} = 10\Omega, V$	$R_G = 10\Omega$, $V_{GE} = 15V$, Inductive Load, $T_C = 25^{\circ}C$		24	48	ns	
Eon	Turn-On S	Switching Loss	Inductive Lo			0.37	-	mJ	
E _{off}	Turn-Off \$	Switching Loss			-	0.16	-	mJ	
E _{ts}	Total Swit	ching Loss			-	0.53	-	mJ	
t _{d(on)}	Turn-On I	Delay Time			-	12	-	ns	
t _r	Rise Time	9			-	16	-	ns	
t _{d(off)}	Turn-Off I	Delay Time	V _{CC} = 400V	, I _C = 20A,	-	95	-	ns	
t _f	Fall Time		R _G = 10Ω, V	/ _{GE} = 15V,	-	28	-	ns	
E _{on}	Turn-On S	Switching Loss	- inductive Lo	ad, T _C = 125 ^o C	-	0.4	-	mJ	
E _{off}	Turn-Off S	Switching Loss			-	0.28	-	mJ	
E _{ts}	Total Swit	ching Loss			-	0.69	-	mJ	
Qg	Total Gate	e Charge			-	65	-	nC	
Q _{ge}	Gate to E	mitter Charge	$V_{CE} = 400V_{CE}$, I _C = 20A,	-	7	-	nC	
Q _{gc}	0.1.1.1.0	ollector Charge	V _{GE} = 15V		-	33	-	nC	

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V_{FM}	Diode Forward Voltage	I _F = 10A	$T_C = 25^{\circ}C$	-	1.9	2.5	V
			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	1.7	-	
t.	r Diode Reverse Recovery Time	I _{ES} =10A, dI _{ES} /dt = 200A/μs	$T_C = 25^{\circ}C$	-	34	-	ns
۲r			$T_{C} = 125^{\circ}C$	-	57	-	
Q _{rr}	Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$	-	41	-	nC
			$T_{C} = 125^{\circ}C$	-	96	-	

Typical Performance Characteristics



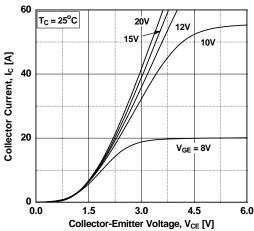


Figure 3. Typical Saturation Voltage Characteristics

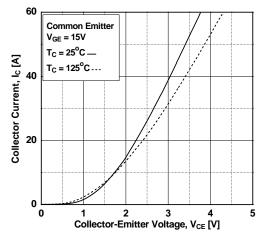


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

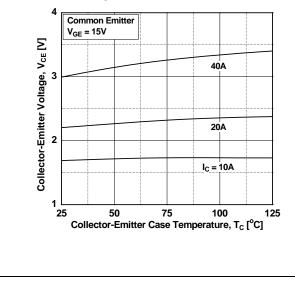


Figure 2. Typical Output Characteristics

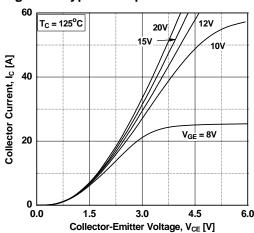


Figure 4. Transfer Characteristics

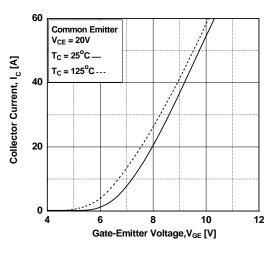
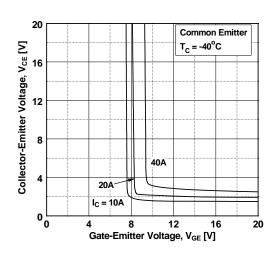
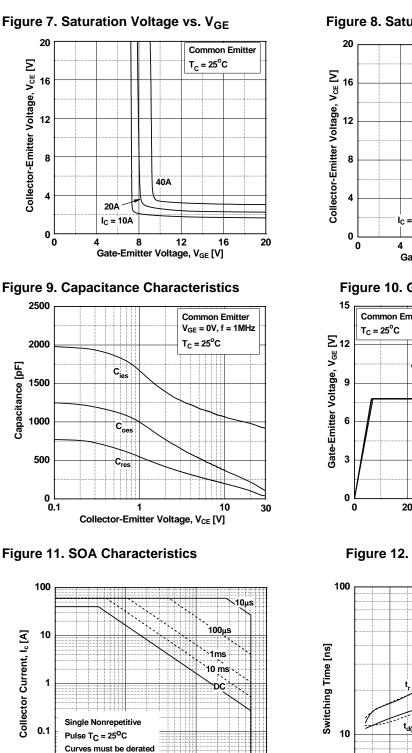


Figure 6. Saturation Voltage vs. V_{GE}



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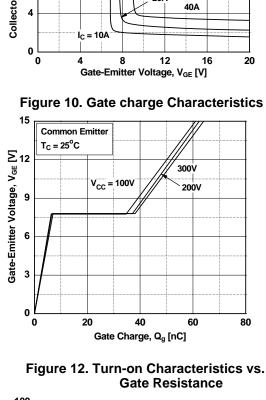
Typical Performance Characteristics

Figure 8. Saturation Voltage vs. V_{GE}

Common Emitter

T_C = 125°C

20A



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linearly with increase

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Collector-Emitter Voltage, V_{CE} [V]

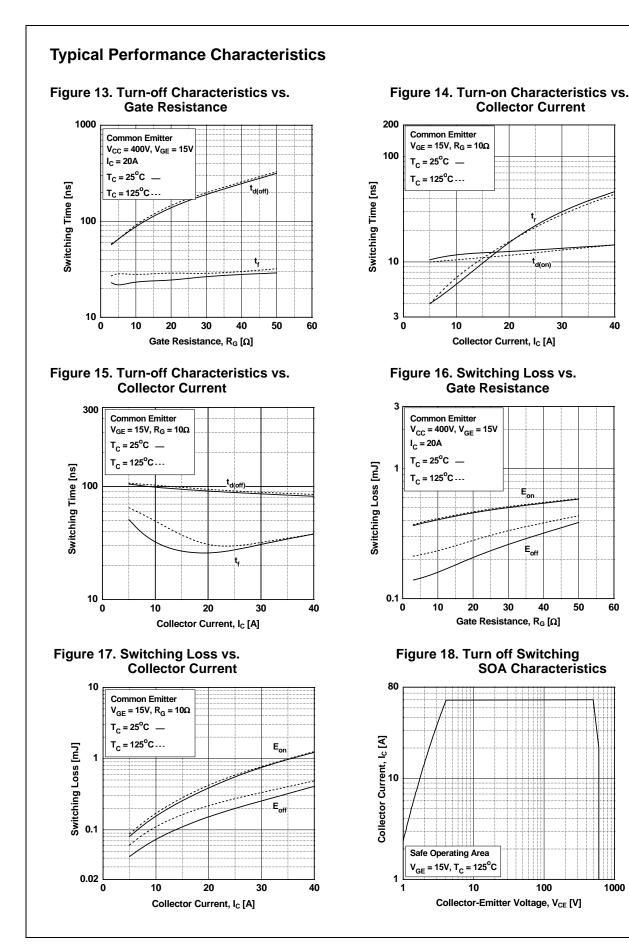
100

in temperature

1000

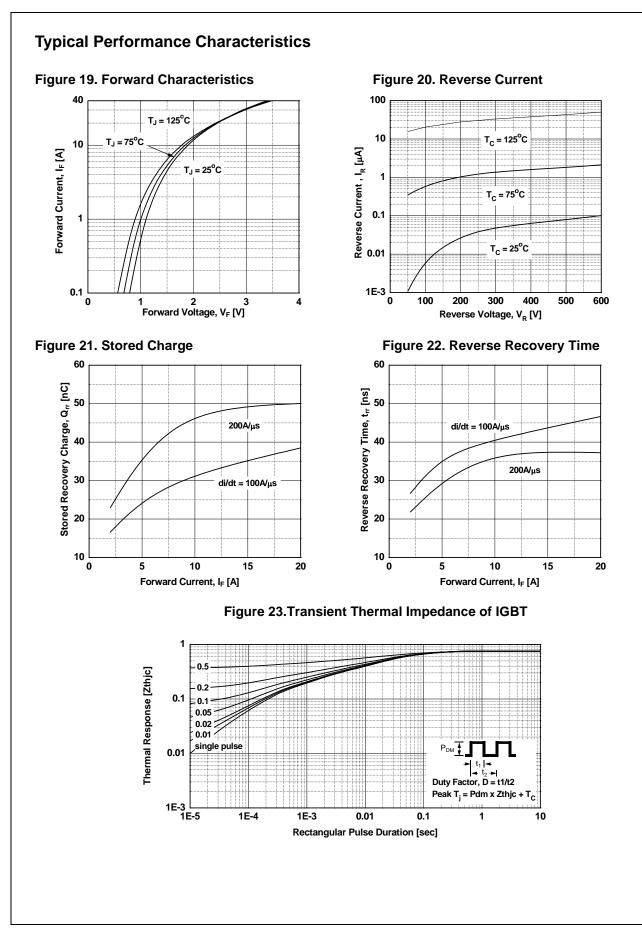
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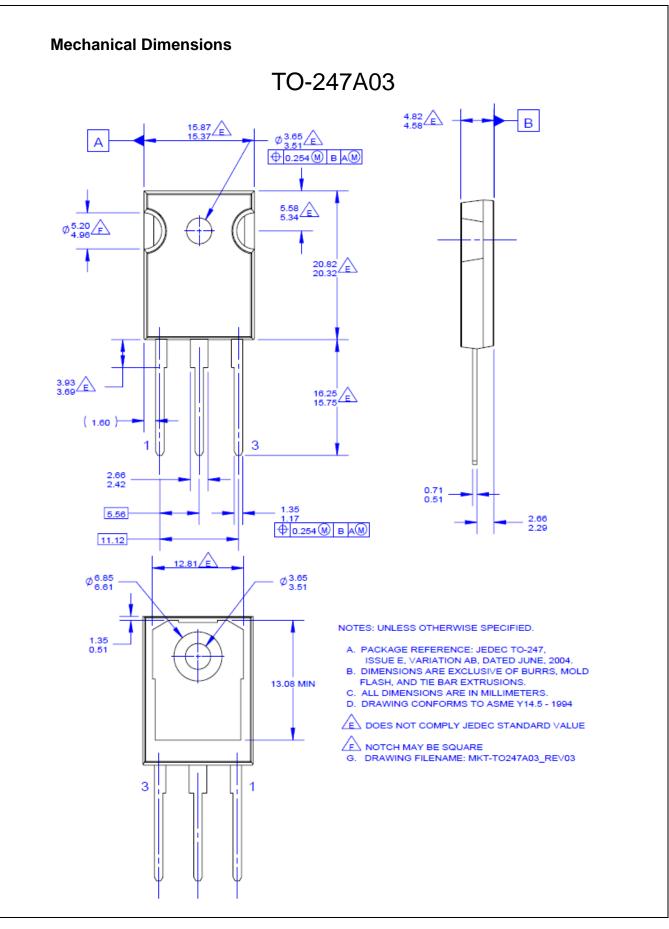
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